Short update on FEC lab and packaging process status

Hamburg-CMS Tracker Upgrade Meeting - Phase I 22 Feb 2013







Phone meeting with Pac Tech clarified present and future processes TOPICS

Sample introduction (analogROC wafer, VTT dummies, Sensor wafers)

Time line for present orders

FEC will visit all process steps during this setup phase

Laser marking of ROC backside possible

Discussion started on

- How to define correctly singulation according to pick map?
- How laser marks could look like?
- When and how is Pac Tech expected to process for BPIX production in the long term?

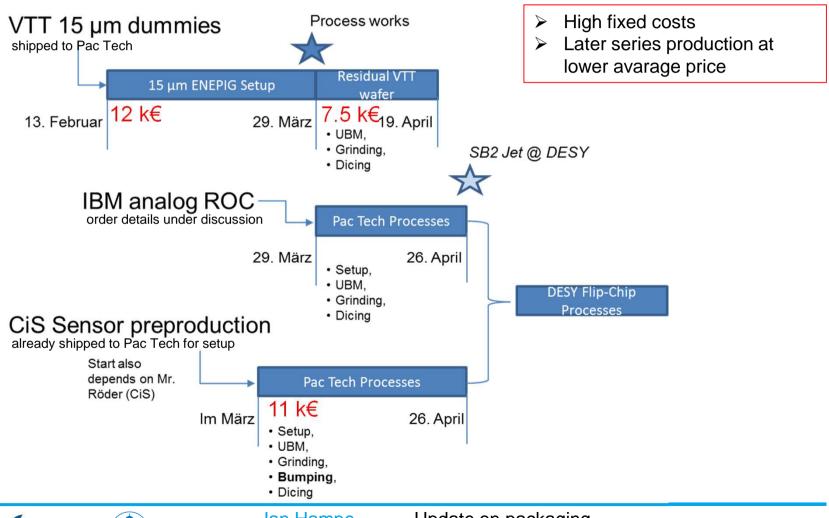






Several orders out for Pac Tech processes

JOINTLY AGREED TIME LINE







FEC lab is under construction for the cleanroom and packaging installation

PICTURES FROM THE CONSTRUCTION SITE



Emergency exit now is main entrance

Curtain to protect the office from the dirt in the lab;-) New air cooling unit



Lab storage is "sealed"



Foil protects other lab space from dirt and reconstructed lab space from the bright Hamburg sunlight







